



SamHop Microelectronics Corp.



STM8360T

Ver 1.0

Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
40V	6.6A	29 @ V _{GS} =10V
		45 @ V _{GS} =4.5V

PRODUCT SUMMARY (P-Channel)		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
-40V	-5.5A	42 @ V _{GS} =-10V
		65 @ V _{GS} =-4.5V



ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	N-Channel	P-Channel	Units	
V _{DS}	Drain-Source Voltage	40	-40	V	
V _{GS}	Gate-Source Voltage	± 20	± 20	V	
I _D	Drain Current-Continuous ^a	T _C =25°C	6.6	-5.5	A
		T _C =70°C	5.3	-4.4	A
I _{IDM}	-Pulsed ^b	33	-31	A	
E _{AS}	Single Pulse Avalanche Energy ^d	16	19	mJ	
P _D	Maximum Power Dissipation ^a	T _C =25°C	2	W	
		T _C =70°C	1.28	W	
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150		°C	

THERMAL CHARACTERISTICS

R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	62.5	°C/W
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Details are subject to change without notice.

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N-Channel ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=250\mu\text{A}$	40			V
I_{DSS}	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=32\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$		1		μA
I_{GSS}	Gate-Body Leakage Current	$\text{V}_{\text{GS}}= \pm 20\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$, $\text{I}_D=250\mu\text{A}$	1.0	1.5	3	V
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$\text{V}_{\text{GS}}=10\text{V}$, $\text{I}_D=6.6\text{A}$		23	29	m ohm
		$\text{V}_{\text{GS}}=4.5\text{V}$, $\text{I}_D=5.3\text{A}$		33	45	m ohm
g_{FS}	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}$, $\text{I}_D=6.6\text{A}$		17		S
DYNAMIC CHARACTERISTICS ^c						
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=20\text{V}, \text{V}_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		780		pF
C_{oss}	Output Capacitance			60		pF
C_{rss}	Reverse Transfer Capacitance			50		pF
SWITCHING CHARACTERISTICS ^c						
$t_{\text{D(ON)}}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=20\text{V}$ $\text{I}_D=1\text{A}$ $\text{V}_{\text{GS}}=10\text{V}$ $\text{R}_{\text{GEN}}=3.3\text{ ohm}$		14		ns
t_r	Rise Time			14		ns
$t_{\text{D(OFF)}}$	Turn-Off Delay Time			18.5		ns
t_f	Fall Time			20		ns
Q_g	Total Gate Charge	$\text{V}_{\text{DS}}=20\text{V}, \text{I}_D=6.6\text{A}, \text{V}_{\text{GS}}=10\text{V}$		14		nC
		$\text{V}_{\text{DS}}=20\text{V}, \text{I}_D=6.6\text{A}, \text{V}_{\text{GS}}=4.5\text{V}$		6.9		nC
Q_{gs}	Gate-Source Charge	$\text{V}_{\text{DS}}=20\text{V}, \text{I}_D=6.6\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$		1.8		nC
Q_{gd}	Gate-Drain Charge			3.9		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I_s	Maximum Continuous Drain-Source Diode Forward Current			1.7		A
V_{SD}	Diode Forward Voltage ^b	$\text{V}_{\text{GS}}=0\text{V}, I_s=1.7\text{A}$		0.77	1.2	V

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P-Channel ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$, $\text{I}_D=-250\mu\text{A}$	-40			V
I_{DS}	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=-32\text{V}$, $\text{V}_{\text{GS}}=0\text{V}$			-1	μA
I_{GSS}	Gate-Body Leakage Current	$\text{V}_{\text{GS}}= \pm 20\text{V}$, $\text{V}_{\text{DS}}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$, $\text{I}_D=-250\mu\text{A}$	-1.0	-1.7	-3	V
$\text{R}_{\text{DS}(\text{ON})}$	Drain-Source On-State Resistance	$\text{V}_{\text{GS}}=-10\text{V}$, $\text{I}_D=-5.5\text{A}$		33	42	m ohm
		$\text{V}_{\text{GS}}=-4.5\text{V}$, $\text{I}_D=-4.4\text{A}$		48	65	m ohm
g_{FS}	Forward Transconductance	$\text{V}_{\text{DS}}=-5\text{V}$, $\text{I}_D=-5.5\text{A}$		12		S
DYNAMIC CHARACTERISTICS ^c						
C_{iss}	Input Capacitance	$\text{V}_{\text{DS}}=-20\text{V}, \text{V}_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		980		pF
C_{oss}	Output Capacitance			135		pF
C_{rss}	Reverse Transfer Capacitance			90		pF
SWITCHING CHARACTERISTICS ^c						
$t_{\text{D}(\text{ON})}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=-20\text{V}$ $\text{I}_D=-1\text{A}$ $\text{V}_{\text{GS}}=-10\text{V}$ $\text{R}_{\text{GEN}}=3\text{ ohm}$		12		ns
t_r	Rise Time			17		ns
$t_{\text{D}(\text{OFF})}$	Turn-Off Delay Time			82		ns
t_f	Fall Time			35		ns
Q_g	Total Gate Charge	$\text{V}_{\text{DS}}=-20\text{V}, \text{I}_D=-5.5\text{A}, \text{V}_{\text{GS}}=-10\text{V}$		20.7		nC
		$\text{V}_{\text{DS}}=-20\text{V}, \text{I}_D=-5.5\text{A}, \text{V}_{\text{GS}}=-4.5\text{V}$		11		nC
Q_{gs}	Gate-Source Charge	$\text{V}_{\text{DS}}=-20\text{V}, \text{I}_D=-5.5\text{A},$ $\text{V}_{\text{GS}}=-10\text{V}$		1.5		nC
Q_{gd}	Gate-Drain Charge			6.2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I_s	Maximum Continuous Drain-Source Diode Forward Current				-1.7	A
V_{SD}	Diode Forward Voltage ^b	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=-1.7\text{A}$		-0.76	-1.2	V
Notes						
a.Surface Mounted on FR4 Board, $t \leq 10\text{sec}$.						
b.Pulse Test:Pulse Width $\leq 300\text{us}$, Duty Cycle $\leq 2\%$.						
c.Guaranteed by design, not subject to production testing.						
d.Starting $T_J=25^\circ\text{C}$, $L=0.5\text{mH}$, $\text{V}_{\text{DD}} = 20\text{V}$, $\text{V}_{\text{GS}}=10\text{V}$. (See Figure13)						

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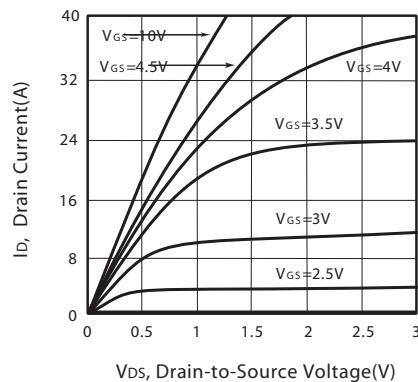


Figure 1. Output Characteristics

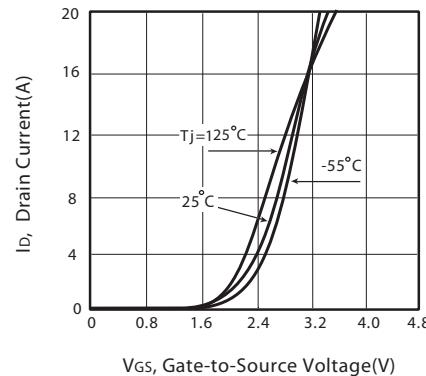


Figure 2. Transfer Characteristics

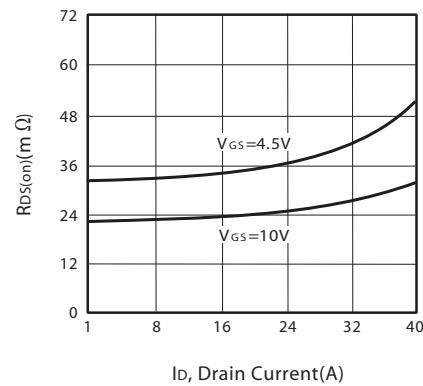


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

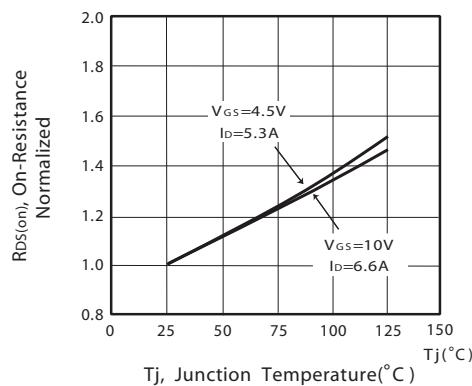


Figure 4. On-Resistance Variation with Drain Current and Temperature

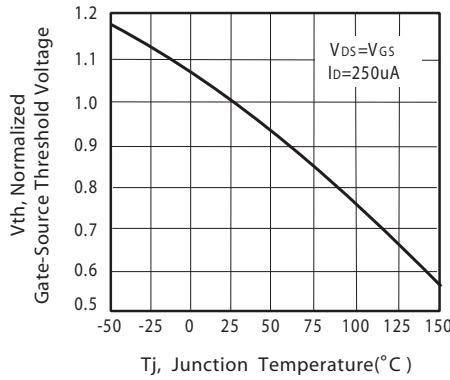


Figure 5. Gate Threshold Variation with Temperature

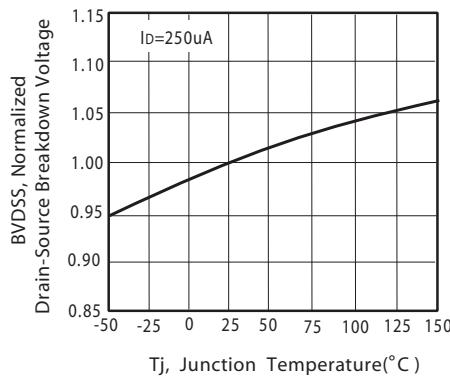


Figure 6. Breakdown Voltage Variation with Temperature

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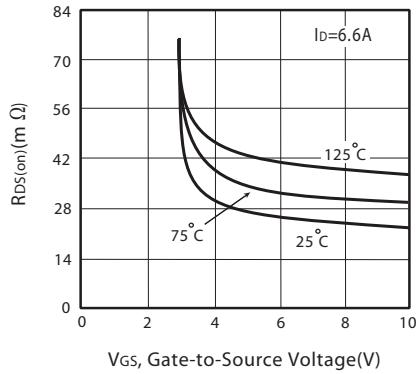


Figure 7. On-Resistance vs.
Gate-Source Voltage

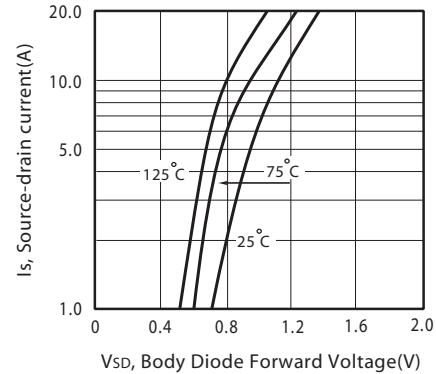


Figure 8. Body Diode Forward Voltage
Variation with Source Current

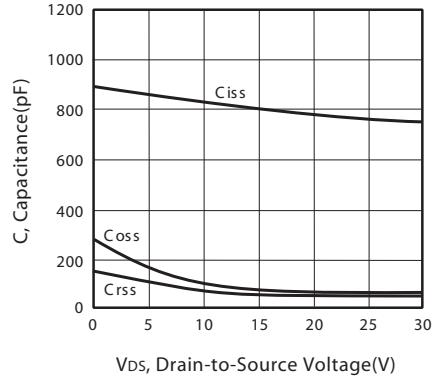


Figure 9. Capacitance

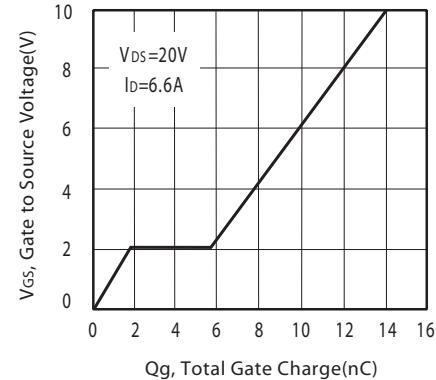


Figure 10. Gate Charge

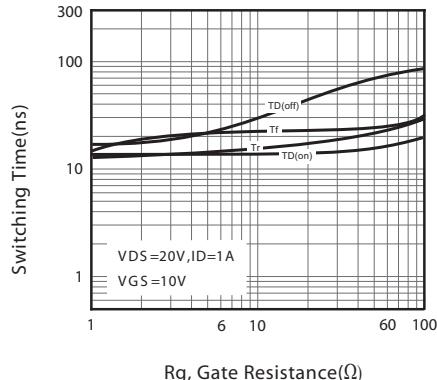


Figure 11. switching characteristics

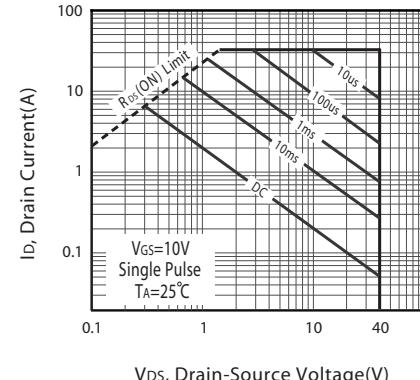
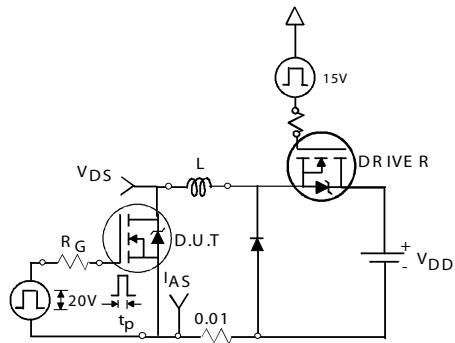


Figure 12. Maximum Safe Operating Area

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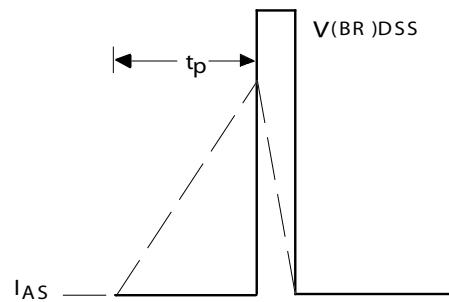
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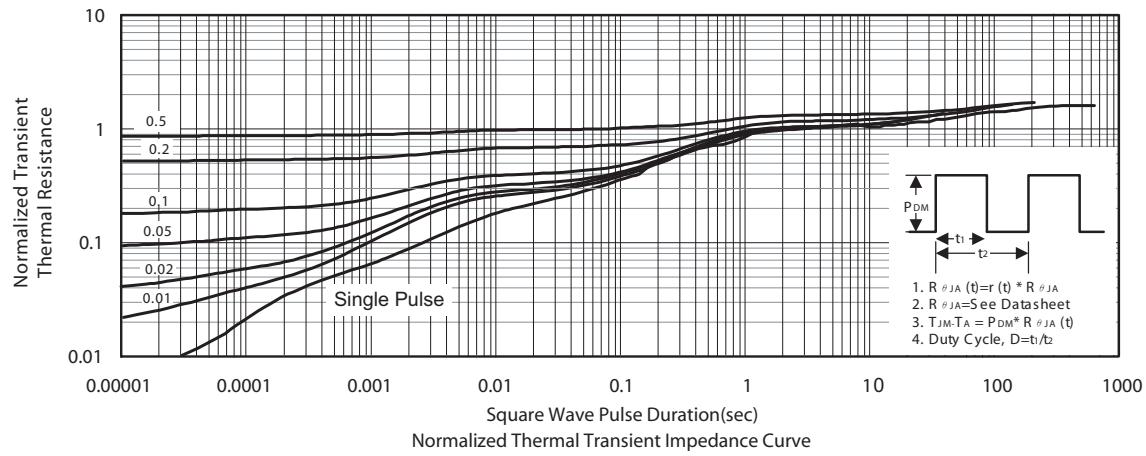
Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.



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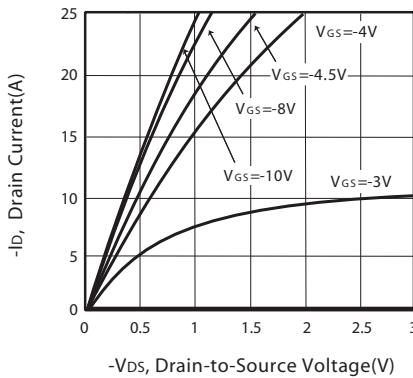


Figure 1. Output Characteristics

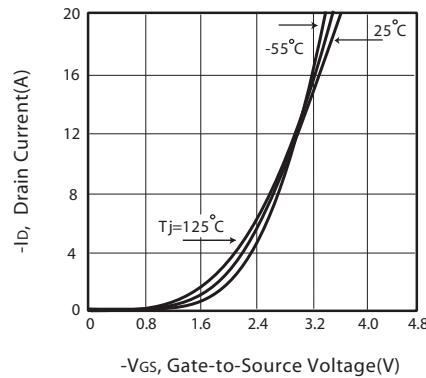


Figure 2. Transfer Characteristics

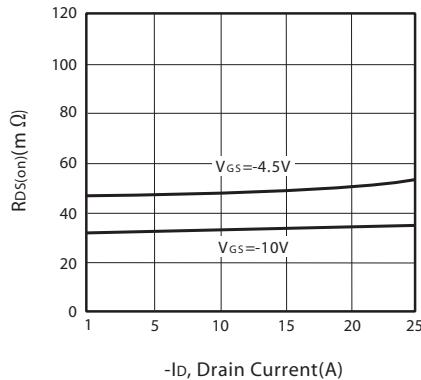


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

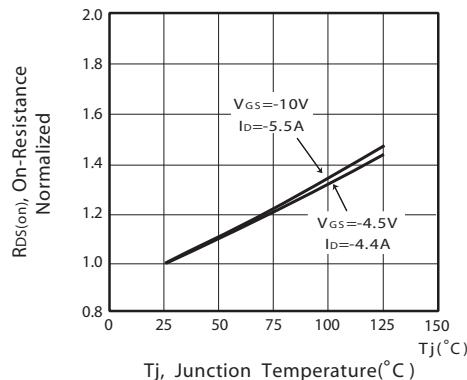


Figure 4. On-Resistance Variation with Drain Current and Temperature

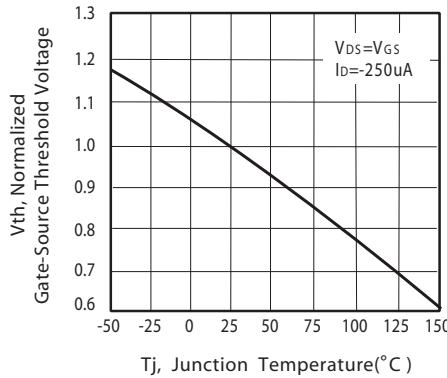


Figure 5. Gate Threshold Variation with Temperature

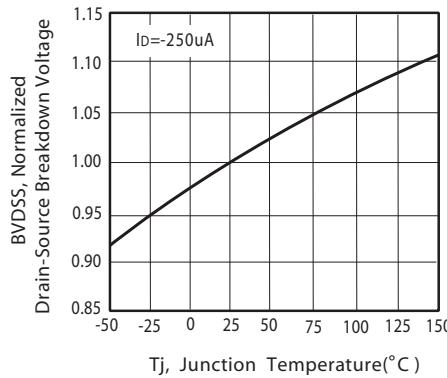


Figure 6. Breakdown Voltage Variation with Temperature

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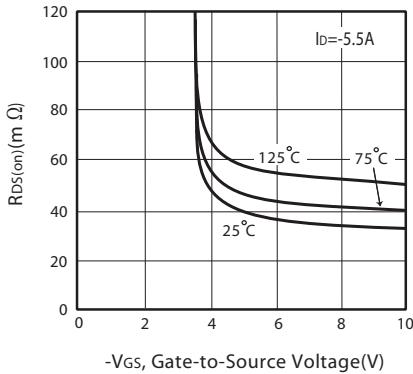


Figure 7. On-Resistance vs.
Gate-Source Voltage

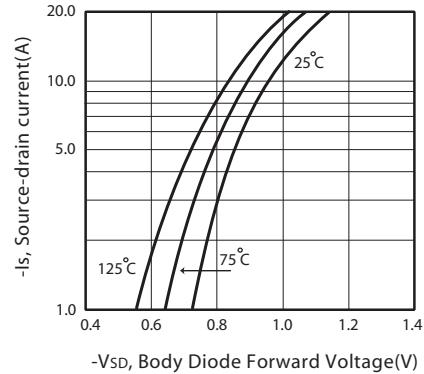


Figure 8. Body Diode Forward Voltage
Variation with Source Current

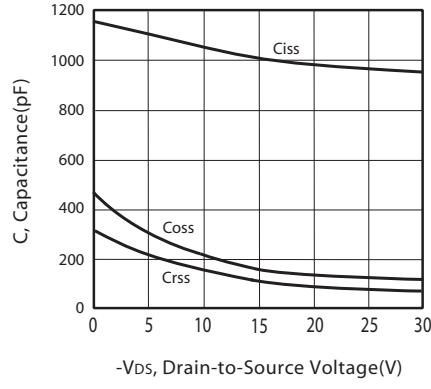


Figure 9. Capacitance

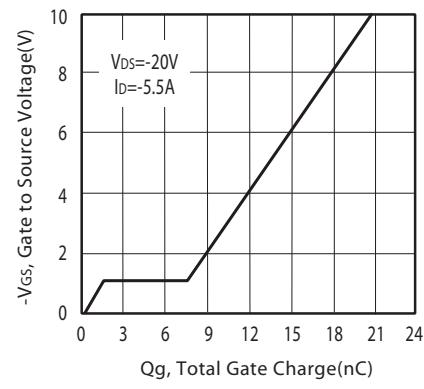


Figure 10. Gate Charge

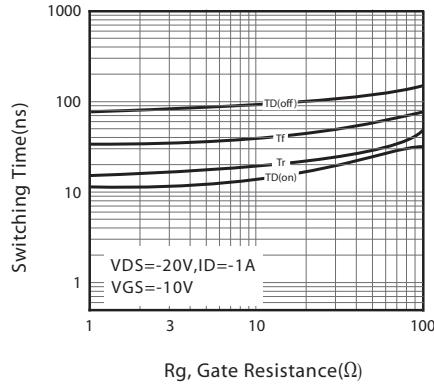


Figure 11. switching characteristics

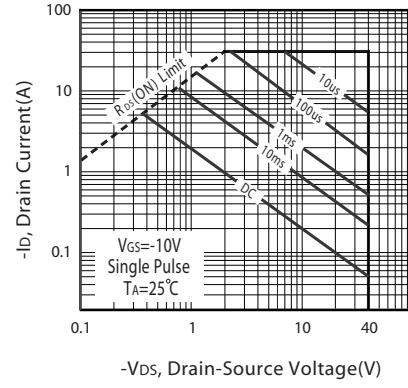
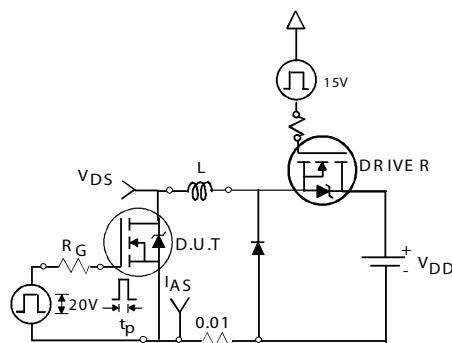


Figure 12. Maximum Safe Operating Area

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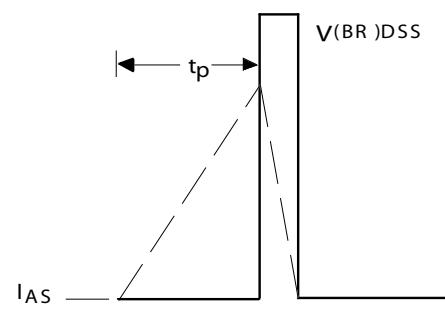
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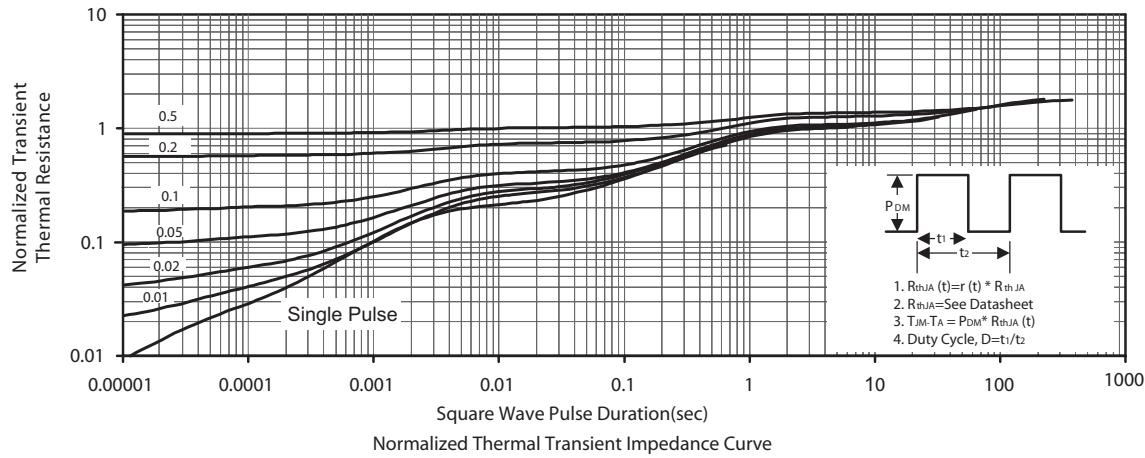
Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.



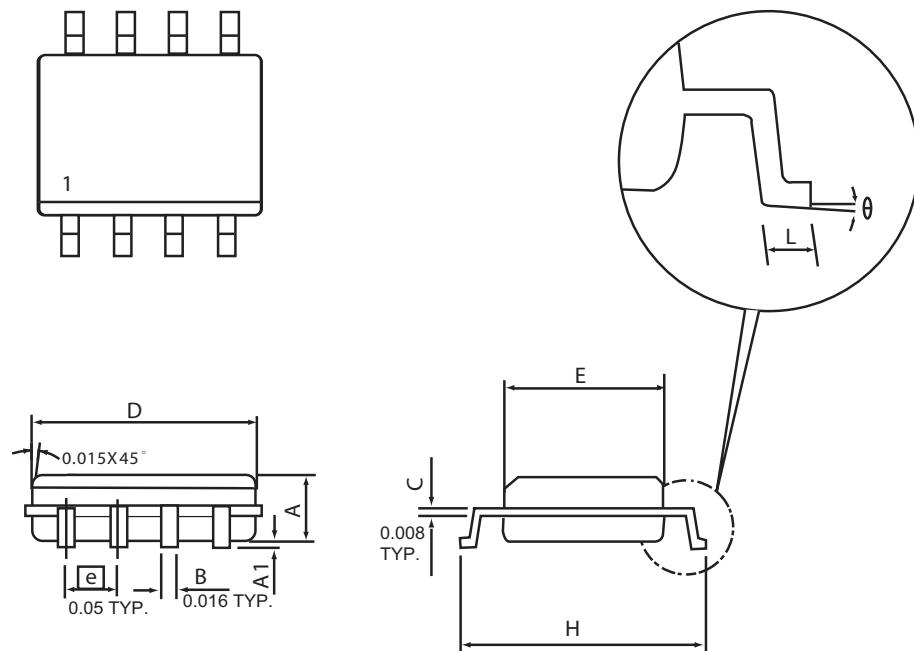
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PACKAGE OUTLINE DIMENSIONS

SO-8



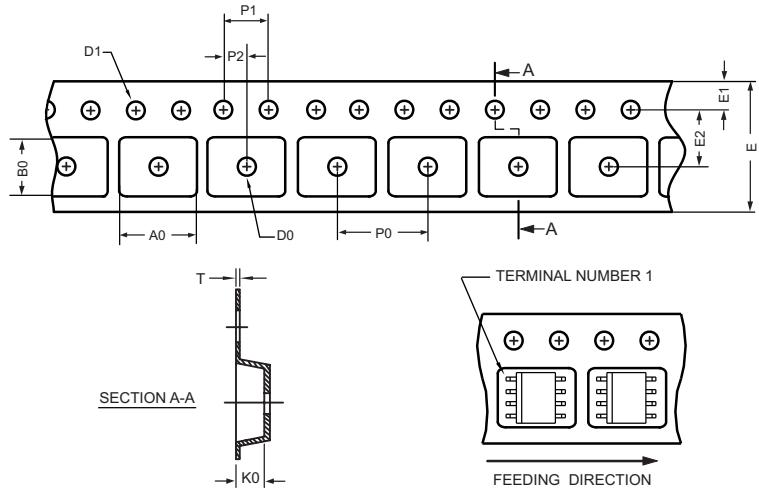
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
θ	0°	8°	0°	8°

Notes : SO-8 package weight : 0.083g

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SO-8 Tape and Reel Data

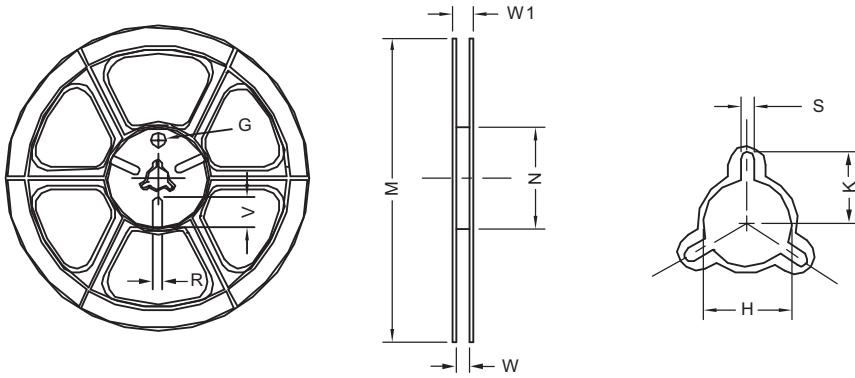
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ± 0.15	5.25 ± 0.10	2.10 ± 0.10	$\phi 1.5$ (MIN)	$\phi 1.55$ ± 0.10	12.0 $+0.3$ -0.1	1.75 ± 0.10	5.5 ± 0.10	8.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.10	0.30 ± 0.013

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 ± 1	62 ± 1.5	$12.4 +0.2$	$16.8 -0.4$	$\phi 12.75 +0.15$	---	2.0 ± 0.15	---	---	---